



DILB8P-223TLF Information



For Reference Only

Part Number DILB8P-223TLF Manufacturer Amphenol FCI

Category Connectors, Interconnects Sockets for ICs, Transistors

Description CONN IC DIP SOCKET 8POS TIN

Package -

For the pricing/inventory/lead time, please contact

us

Website: https://www.heisener.com E-mail: salesdept@heisener.com



Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.









DILB8P-223TLF Specifications

Manufacturer Part Number	DILB8P-223TLF
Manufacturer	Amphenol FCI
Category	Connectors, Interconnects
	Sockets for ICs, Transistors
Package	-
Series	-
Туре	DIP, 0.3" (7.62mm) Row Spacing
Number of Positions or Pins (Grid)	8 (2 x 4)
Pitch - Mating	0.100" (2.54mm)
Contact Finish - Mating	Tin
Contact Finish Thickness - Mating	100μin (2.54μm)
Contact Material - Mating	Copper Alloy
Mounting Type	Through Hole
Features	Open Frame
Termination	Solder
Pitch - Post	0.100" (2.54mm)
Contact Finish - Post	Tin
Contact Finish Thickness - Post	100μin (2.54μm)
Contact Material - Post	Copper Alloy
Housing Material	Polyamide (PA), Nylon
Operating Temperature	-55°C ~ 105°C
	Report errors?

DILB8P-223TLF Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

DILB8P-223TLF Payment Methods



















DILB8P-223TLF Shipping Methods













If you have any question about DILB8P-223TLF, please do not hesitate to contact us!

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